

## Description

The LY236AA05 is a TVS array, utilizing leading monolithic silicon technology to provide fast response time and low ESD clamping voltage, making this device an ideal solution for protecting voltage sensitive portable electronics. It complies with IEC 61000-4-2 (ESD),  $\pm 30\text{kV}$  air and  $\pm 30\text{kV}$  contact discharge. It is assembled into a lead-free SOT23-6 package.

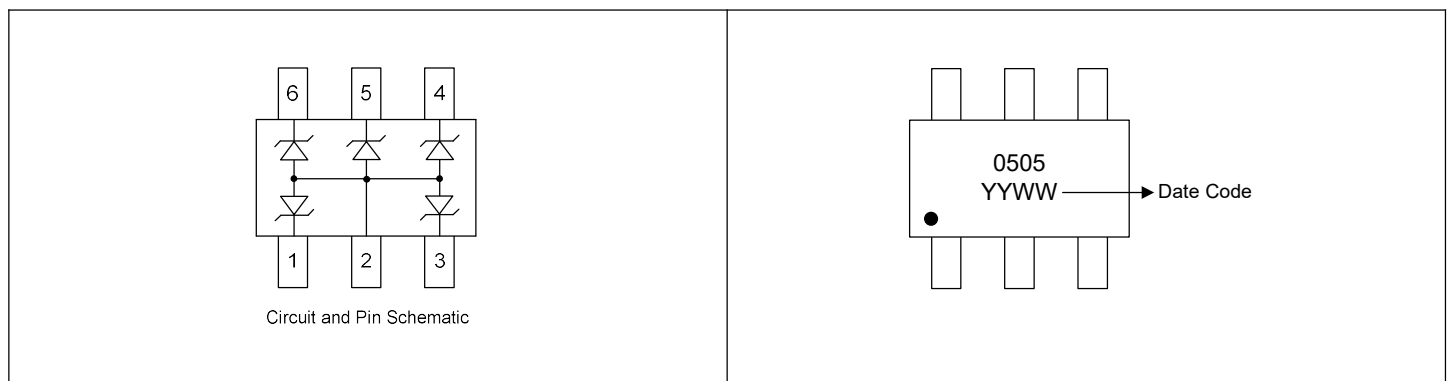
## Features

- Low clamping voltage
- Ultra low leakage current
- Operating voltage: 5V
- RoHS compliant
- IEC-61000-4-2 ESD  $\pm 30\text{kV}$  Air,  $\pm 30\text{kV}$  Contact
- Packaging: 7 inch reel, 3000pcs/reel

## Applications

- Cell Phone Handsets and Accessories
- Desktops PC, Laptops and Servers
- Microprocessor Based Equipment
- Audio Players
- Set Top Box
- Peripherals

## Pin Configuration and Marking



### Absolute Maximum Ratings ( $T_A=25^{\circ}\text{C}$ )

Parameter	Symbol	Value
Peak Pulse Power (8/20 $\mu\text{s}$ )	$P_{PP}$	100W
Peak Pulse Current (8/20 $\mu\text{s}$ )	$I_{PP}$	8A
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	$V_{ESD}$	$\pm 30\text{kV}$ $\pm 30\text{kV}$
Ambient Temperature Range	$T_A$	$-55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$
Storage Temperature Range	$T_{STG}$	$-55^{\circ}\text{C}$ to $+150^{\circ}\text{C}$

### Electrical Characteristics ( $T_A=25^{\circ}\text{C}$ )

Parameter	Symbol	Test Condition	Min.	Typ.	Max.
Reverse Working Voltage	$V_{RWM}$		-	-	5V
Breakdown Voltage	$V_{BR}$	$I_T = 1\text{mA}$	6V	-	8.5V
Reverse Leakage Current	$I_R$	$V_{RWM} = 5\text{V}$	-	-	0.2 $\mu\text{A}$
Clamping Voltage	$V_C$	$I_{PP} = 1\text{A}$ (8/20 $\mu\text{s}$ )	-	-	8V
		$I_{PP} = 8\text{A}$ (8/20 $\mu\text{s}$ )	-	-	12V
Junction Capacitance	$C_J$	$V_R = 0\text{V}$ , $f = 1\text{MHz}$	-	60pF	-

Typical Characteristic Curves ( $T_A=25^\circ\text{C}$ )

Figure 1. Peak Pulse Power Rating Curve

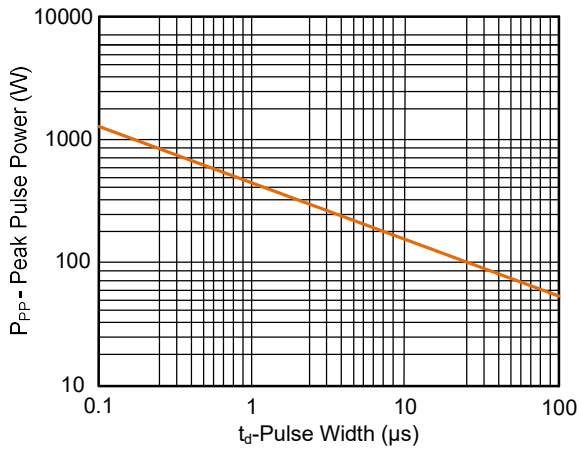


Figure 2. Pulse Derating Curve

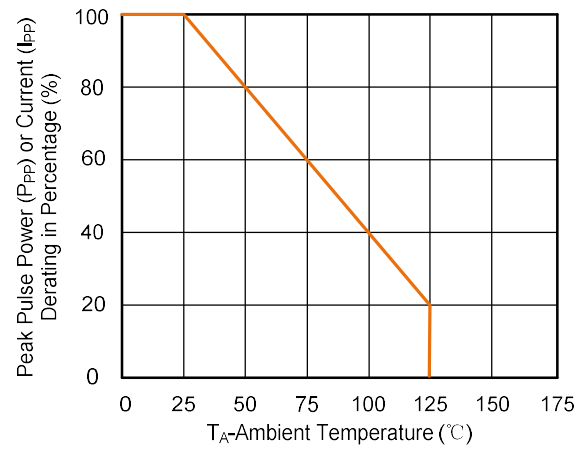


Figure 3. Clamping Voltage vs. Peak Pulse Current

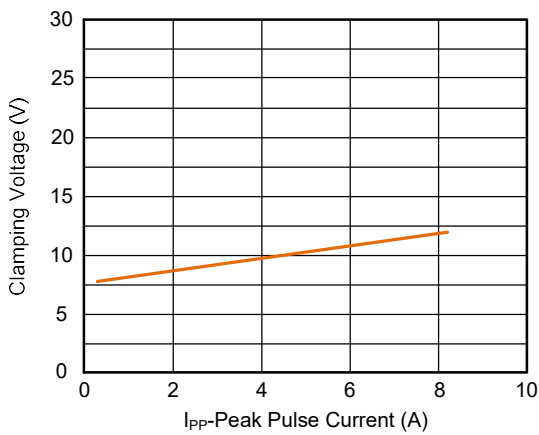


Figure 4. Junction Capacitance vs. Reverse Voltage

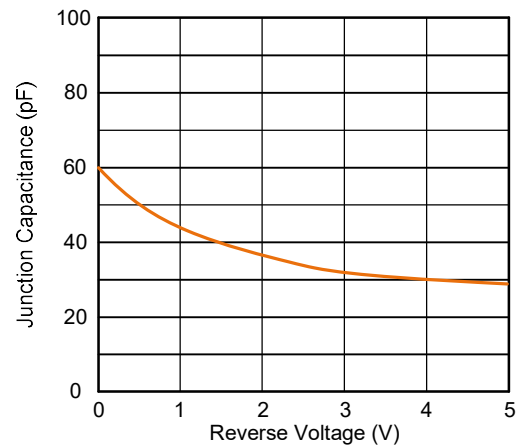


Figure 5. Pulse Waveform (8/20μs)

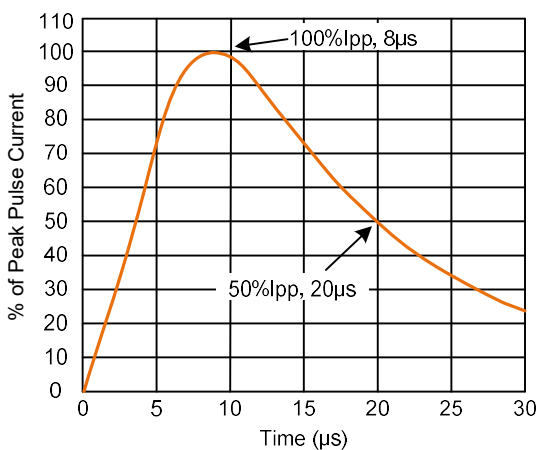
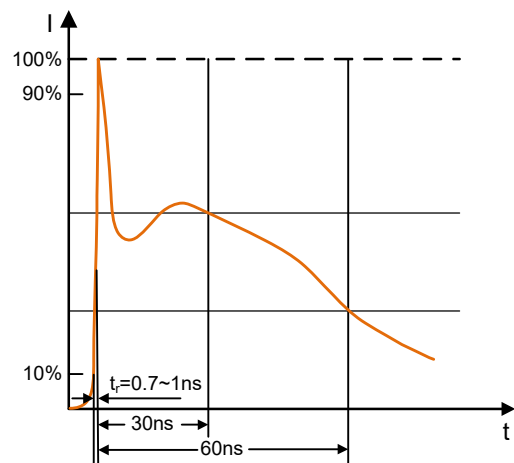
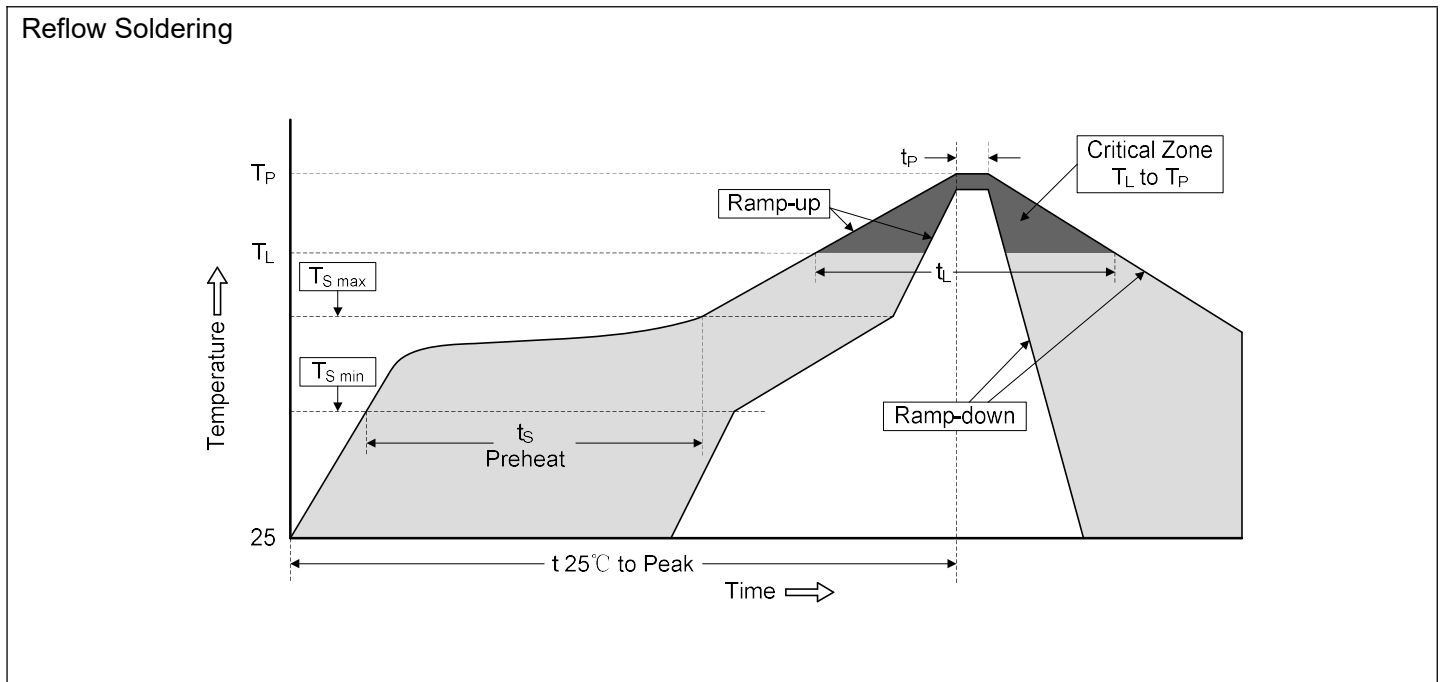


Figure 6. Pulse Waveform (IEC61000-4-2)



## Soldering Parameters



Profile Feature	Pb-Free Assembly
Average ramp-up rate ( $T_L$ to $T_P$ )	3°C/second max.
Preheat -Temperature Min ( $T_{S\ min}$ ) -Temperature Max ( $T_{S\ max}$ ) -Time (min to max) ( $t_s$ )	150°C 200°C 60-180 seconds
$T_{S\ max}$ to $T_L$ -Ramp-up Rate	3°C/second max.
Time maintained above: -Temperature ( $T_L$ ) -Time ( $t_L$ )	217°C 60-150 seconds
Peak Temperature ( $T_P$ )	260°C
Time within 5°C of actual Peak Temperature ( $t_p$ )	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

**Dimensions (SOT23-6)**

